

The MPC94551 is a CMOS 1:4 fanout buffer. The MPC94551 is ideal for applications requiring lower voltage.

Features

- 1:4 CMOS fanout buffer
- 300 ps output to output skew
- I/O frequency up to 160 MHz operation
- Non-inverting output clock
- 3.3 V supply voltage
- Output Enable mode tri-states outputs
- -40°C to 85°C industrial temperature range
- 8-lead SOIC package, Pb-free
- **For drop in replacement use 551MI**

MPC94551

**1:4 LVC MOS
CLOCK BUFFER**



**EF SUFFIX
8-LEAD SOIC PACKAGE
Pb-FREE PACKAGE
CASE 751-06**

ORDERING INFORMATION	
Device	Package
MPC94551EF	SO-8 (Pb-FREE)
MPC94551EFR2	SO-8 (Pb-FREE)

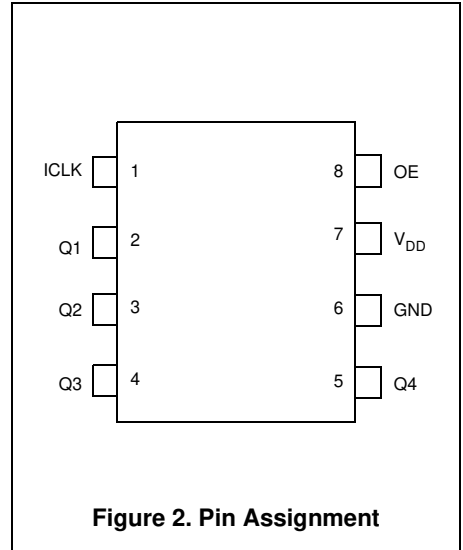
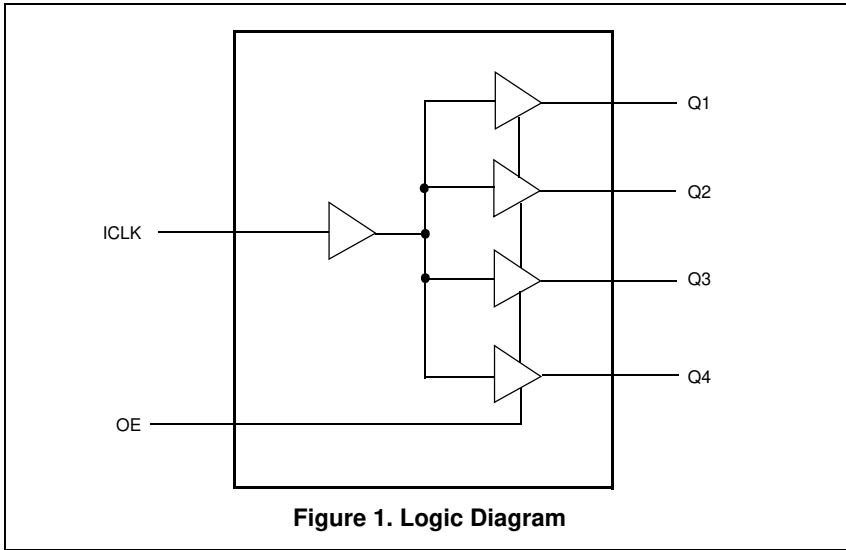


Table 1. Pin Description

Pin Number	Pin Name	Pin Type	Pin Description
1	ICLK	Input	Clock input, internal pull-up resistor
2	Q1	Output	Clock output ⁽¹⁾
3	Q2	Output	Clock output ⁽¹⁾
4	Q3	Output	Clock output ⁽¹⁾
5	Q4	Output	Clock output ⁽¹⁾
6	GND	Power	Connect to ground ⁽²⁾
7	V _{DD}	Power	Connect to 3.3 V ⁽²⁾
8	OE	Input	Output enable, tri-states outputs when low, internal pull-up resistor

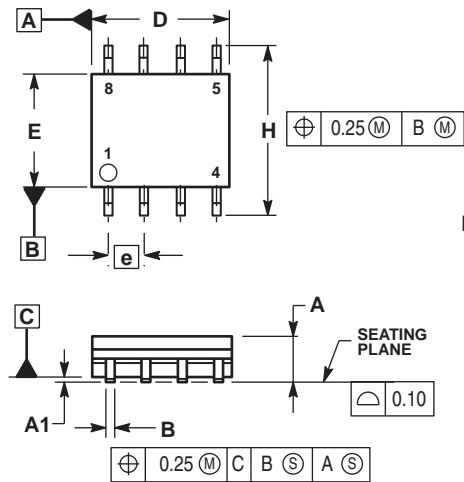
1. A 33 Ω series terminating resistor may be used on each clock output if the trace is longer than 1 inch.
2. A decoupling capacitor of 0.01 μF should be connected between V_{DD} on pin 7 and GND on pin 6, as close to the device as possible.

Table 2. Absolute Maximum Ratings⁽¹⁾

Parameter	Rating	Unit
Power Supply Voltage, V _{DD}	3.9	V
All Inputs and Outputs	-0.5 to V _{DD} +0.5	V
Ambient Operating Temperature	-40 to +85	°C
Storage Temperature	-65 to +150	°C
Junction Temperature	175	°C
Soldering Temperature	260	°C

PACKAGE DIMENSIONS

1. Stresses above the ratings listed below can cause permanent damage to the device. These ratings are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Dimensions for absolute maximum ratings conditions for extended periods are not guaranteed. Electrical characteristics are guaranteed at 25°C.



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. DIMENSIONS ARE IN MILLIMETER.
 3. DIMENSION D AND E DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 TOTAL IN EXCESS OF THE B DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS	
	MIN	MAX
A	1.35	1.75
A1	0.10	0.25
B	0.35	0.49
C	0.19	0.25
D	4.80	5.00
E	3.80	4.00
e	1.27 BSC	
H	5.80	6.20
h	0.25	0.50
L	0.40	1.25
θ	0°	7°

Input Capacitance	C _{IN}	OE pin	D/EF SUFFIX	5	pF
	C _{IN}	ICLK	SOIC PACKAGE	1	pF
Short Circuit Current	I _{OS}		CASE 751-06	±50	mA

1. Nominal switching threshold is V_{DD}/2.

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Table 4. AC Characteristics ($V_{DD} = 3.3\text{ V} \pm 5\%$; Ambient Temperature = -40°C to 85°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Input Frequency			0		160	MHz
Output Frequency ⁽¹⁾		15 pF load			160	MHz
Output Clock Rise Time	t_{OR}	0.8 V to 2.0 V			1.5	ns
Output Clock Fall Time	t_{OF}	2.0 V to 0.8 V			1.5	ns
Propagation Delay ⁽²⁾		135 MHz	1.5	4	5	ns
Output to Output Skew ⁽³⁾		Rising edges at $V_{DD}/2$			300	ps

1. Measured with an external series resistor of 33Ω positioned close to each output pin
2. Measured with rail to rail input clock
3. Measured between any 2 outputs with equal loading

Revision History Sheet

Rev	Table	Page	Description of Change	Date
4		1	NRND – Not Recommend for New Designs	12/21/12
4		1	Removed NRND	5/5/15
4		1	Product Discontinuation Notice - Last time buy expires September 7, 2016. PDN N-16-02	3/15/16

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